

PATENT

Case Docket No. MEISS69.001AUS

Date: November 30, 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: FARASSAT, Farhad

App. No. : 10/090,083

Filed

: March 1, 2002

For

: METHOD OF TESTING BONDED

CONNECTIONS, AND A WIRE BONDER

Examiner: EDMONDSON, Lynne

Art Unit

: 1725

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Mail Stop Amendment, P.O. Box 1450, Alexandria, VA 22313-1450, on

November 30, 2004

James W. Ausley, Reg. No. 49,076

TRANSMITTAL LETZER

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Enclosed for filing in the above-identified application are:

- (X) Supplemental Information Disclosure Statement.
- (X) A PTO Form 1449 citing twenty-two (22) enclosed references.
- (X) A check in the amount of \$180 to cover the fee.
- (X) Return prepaid postcard.
- (X) The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment, to Account No. 11-1410.

fames W. Ausley

Registration No. 49,076

Agent of Record

Customer No. 20,995

(951) 781-9231

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Customer No. 20,995

Docket No.: MEISS69.001AUS



SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

FARASSAT, Farhad

App. No.

10/090,083

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For

METHOD OF TESTING BONDED CONNECTIONS,

AND A WIRE BONDER

Examiner:

EDMONDSON, Lynne

Art Unit

1725

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Enclosed is form PTO-1449 listing twenty-two (22) references that are also enclosed.

This Supplemental Information Disclosure Statement is being filed under 37 C.F.R. § 1.97(c)(2) before the mailing date of a final action and before the mailing of a Notice of Allowance. This Statement is accompanied by the fees set forth in 37 C.F.R. § 1.17(p). The Commissioner is hereby authorized to charge any additional fees which may be required or to credit any overpayment to Account No. 11-1410.

Dated: 11/24/04

12/03/2004 MAHMED1 00000003 10090083

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180.00 DP

Respectfully submitted,

KNOBBE, MARTENS, OLSON & BEAR, LLP

James W. Ausley

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FORM PTO-1449

DEC 8 2 2004 WAS DEPARTMENT OF SOMMERCE PATENT AND TRADES ARK OFFICE

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(USE SEVERAL SHEETS IF NECESSARY)

TTY. DOCKET NO.	APPLICATION NO.
MEISS69.001AUS	10/090,083

APPLICANT FARASSAT, Farhad

FILING DATE March 1, 2002 GROUP 1725

U.S. PATENT DOCUMENTS							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE (IF APPROPRIATE)
	1	US 3,572,108	03/1971	McShane et al.			
	2	US 4,445,378	05/1984	Zuckerwar			
•	3	US 4,453,414	06/1984	Ronemus et al.			
	4	US 4,619,397	10/1986	Urban			
	5	US 4,895,028	01/1990	Mayer			
	6	US 4,907,458	03/1990	Biggs et al.			
	7	US 4,984,730	01/1991	Göbel et al.			4
	8	US 5,213,249	05/1993	Long et al.			
	9	US 5,275,058	01/1994 .	Pham et al.			
	10	US 5,314,105	05/1994	Farassat			
	11	US 6,178,823	01/2001	Sykes			•
	12	US 5,889,210	03/1999	Inoue			
	13	US 6,178,823	01/2001	Sykes			

				FOREIGN PATENT DOCUMENTS				
EXAMINER	DOCUMENT NUMBER DATE COUNTRY CLASS SUBCLA				SUBCLASS	TRANSLATION		
INITIAL							YES	NO
	14	EP 0263542	08/1987	Europe			n/a	
	15	JP 2–90038	03/1990	Japan			abstract only	
	16	GB 2271305	04/1994	Great Britain			n/a	
	17	DE 4447073	07/1996	Germany			abstract only	
	18	EP 0772036	05/1997	Europe			n/a	
	19	JP 2001–118887	04/2001	Japan			abstract only	

EXAMINER

DATE CONSIDERED

*EXAMINER: INITIAL IF CITATION CONSIDERED, WHETHER OR NOT CITATION IS IN CONFORMANCE WITH MPEP 609; DRAW LINE THROUGH CITATION IF NOT IN CONFORMANCE AND NOT CONSIDERED, INCLUDE COPY OF THIS FORM WITH NEXT COMMUNICATION TO APPLICANT.

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FORM	1 PTO-1449	U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	ATTY. DOCKET NO. MEISS69.001AUS	APPLICATION NO. 10/090,083
SUPPLEM	ENTAL INFOR	MATION DISCLOSURE STATEMENT		
BY APPLICANT		/ APPLICANT	APPLICANT FARASSAT, Farhad	
(USE SEVERAL	SHEETS IF NECESSARY)	FILING DATE March 1, 2002	GROUP 1725

EXAMINER INITIAL	OTHER DOCUMENTS (INCLUDING AUTHOR, TITLE, DATE, PERTINENT PAGES, ETC.)				
	"Bond testing enters mainstream PCB assembly" by Paul WALTER, Microelectronics Journal, Mackinstosh Publications LTD. Luton, GB, Bd. 27, Nr. 1, (February 1996)				
	21 "An Improved Wire Bond Pull Test" by Shankara PRASAD and Ali SABOUI, Solid State Technology, Cowan Publ. Corp., Washington, US, Bd. 34, Nr. 6, (June 1991)				
	"Wire Bond Pull Testing Understanding the Geometric Resolution of Forces" by Gil PERLBERG and Cyndy ENMAN, Advanced Packaging, IHS Publishing Group, US, Bd. 3, Nr. 1, (1994)				

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